

## Features

- Protection of Charger Reverse Connection
- Protection of Battery Cell Reverse Connection
- Over-temperature Protection
- Overcharge Current Protection
- Two-step Overcurrent Detection:  
Over Discharge Current  
Load Short Circuiting
- Charger Detection Function
- RoHS Compliant and Lead (Pb) Free
- 45mΩ Low  $R_{SS(ON)}$  Internal Power MOSFET
- Delay Times are generated inside
- High-accuracy Voltage Detection
- Low Current Consumption  
Operation Mode: 2.5μA typ.  
Power-down Mode: 1.5μA typ.
- Only One External Capacitor Required
- Available in SOT23-5 Package
- -40°C to +85°C Temperature Range

## Applications

- One-Cell Li-ion Battery Pack
- Power Bank
- One-Cell Li-poly Battery Pack
- IOT Sensor/Electronic Toys

## Typical Application Circuit

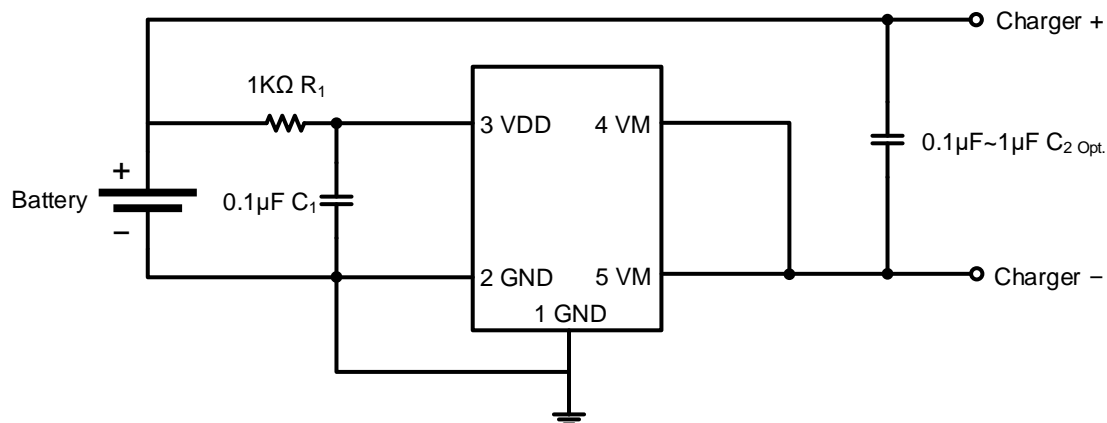


Figure 1. Typical Application Circuit

## Absolute Maximum Ratings <sup>(1) (2)</sup>

VDD Input Voltage .....	-0.3V to 6V	VM Input Voltage .....	-6V to 10V V <sub>BS</sub>
Operating Temperature Range .....	-40°C to +85°C	Storage Temperature Range .....	-55°C to 150°C
Lead Temperature (Soldering, 10s) .....	+300°C	Junction Temperature.....	+125°C
θ <sub>JA</sub> .....	250°C/W	ESD (Human Body Made) HMB.....	2KV
θ <sub>JC</sub> .....	130°C/W	ESD (Machine Made) MM.....	200V

Note 1: Exceeding these ratings may damage the device.

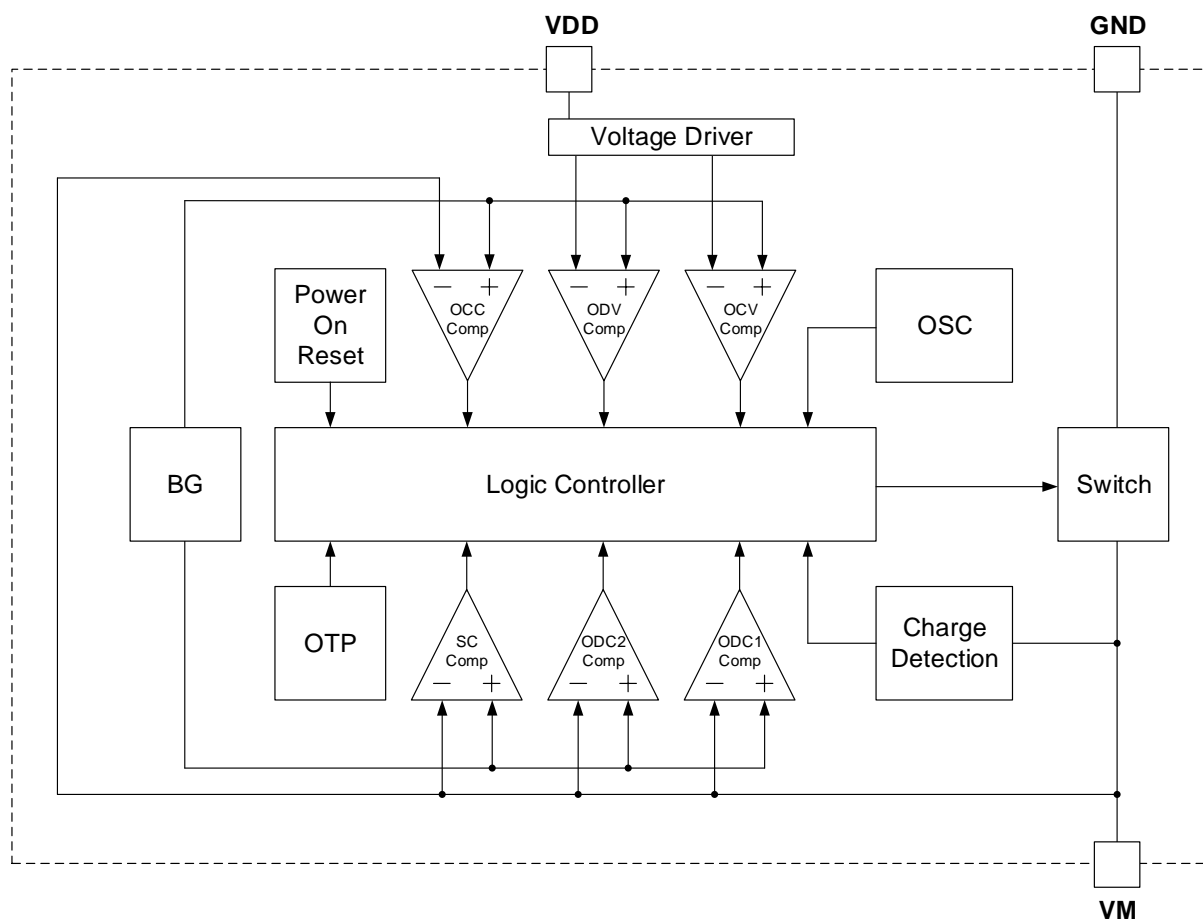
Note 2: The device is not guaranteed to function outside of its operating conditions.

## Electrical Characteristics <sup>(3)</sup>

Parameter	Symbol	Test Conditions	Min	Typ.	Max	Unit
<b>Detection Voltage</b>						
Overcharge Detection Voltage	V <sub>CU</sub>		4.25	4.3	4.35	V
Overcharge Release Voltage	V <sub>CL</sub>		4.05	4.1	4.15	V
Overdischarge Detection Voltage	V <sub>DL</sub>		2.3	2.4	2.5	V
Overdischarge Release Voltage	V <sub>DR</sub>		2.9	3.0	3.1	V
Charger Detection Voltage	*V <sub>CHA</sub>			-0.12		V
<b>Detection Current</b>						
Overdischarge Current1 Detection	*I <sub>IOV1</sub>	V <sub>DD</sub> =3.6V		3		A
Load Short-Circuiting Detection	*I <sub>SHORT</sub>	V <sub>DD</sub> =3.6V		15		A
<b>Current Consumption</b>						
Current Consumption in Operation	I <sub>OPE</sub>	V <sub>DD</sub> =3.6V VM=0V		2.5	5	μA
Current Consumption in power Down	I <sub>PDN</sub>	V <sub>DD</sub> =2.0V VM floating		1.5	4	μA
<b>VM Internal Resistance</b>						
Resistance between VM and V <sub>DD</sub>	*R <sub>VMD</sub>	V <sub>DD</sub> =3.6V VM=1.0V		320		kΩ
Resistance between VM and GND	*R <sub>VMS</sub>	V <sub>DD</sub> =2.0V VM=1.0V		25		kΩ
<b>FET on Resistance</b>						
Equivalent FET on Resistance	*R <sub>SS(ON)</sub>	V <sub>DD</sub> =3.6V I <sub>VM</sub> =1.0A		45		mΩ
<b>Over Temperature Protection</b>						
Over Temperature Protection	*T <sub>SHD+</sub>			130		°C
Over Temperature Recovery Degree	*T <sub>SHD-</sub>			100		°C
<b>Detection Delay Time</b>						
Overcharge Voltage Detection Delay Time	t <sub>CU</sub>			128	200	mS
Overdischarge Voltage Detection Delay Time	t <sub>DL</sub>			40	60	mS
Overdischarge Current Detection Delay Time	*t <sub>IOV</sub>	V <sub>DD</sub> =3.6V		10		mS
Load Short-Circuiting Detection Delay Time	*t <sub>SHORT</sub>	V <sub>DD</sub> =3.6V		80		μS

Note 3: \*The parameter is guaranteed by design.

## Functional Block Diagram



## Overdischarge current detection

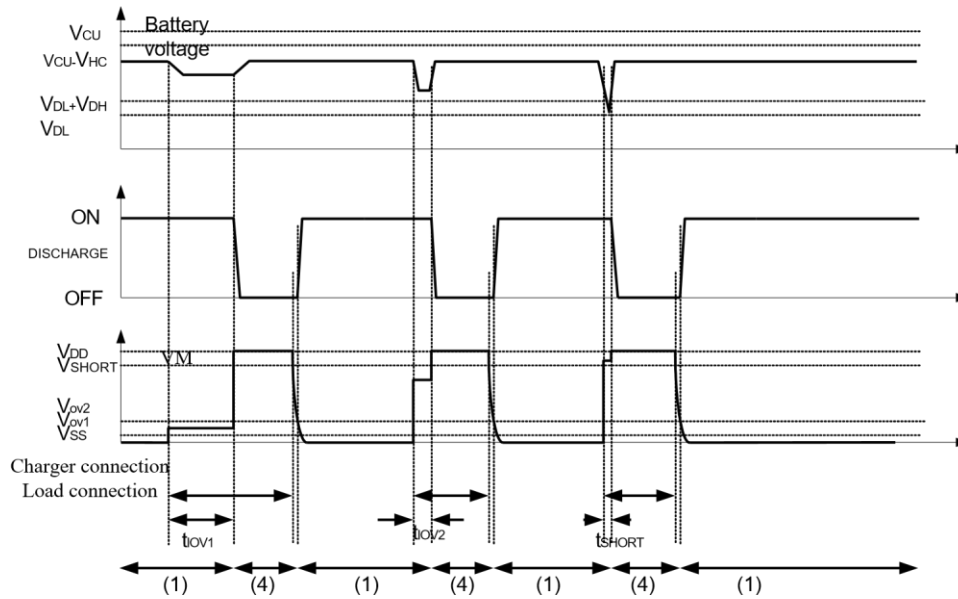


Figure5-2 Overdischarge Current Detection

### Remark:

- (1) Normal condition (2) Overcharge voltage condition  
(3) Overdischarge voltage condition (4) Overcurrent condition

## Charger Detection

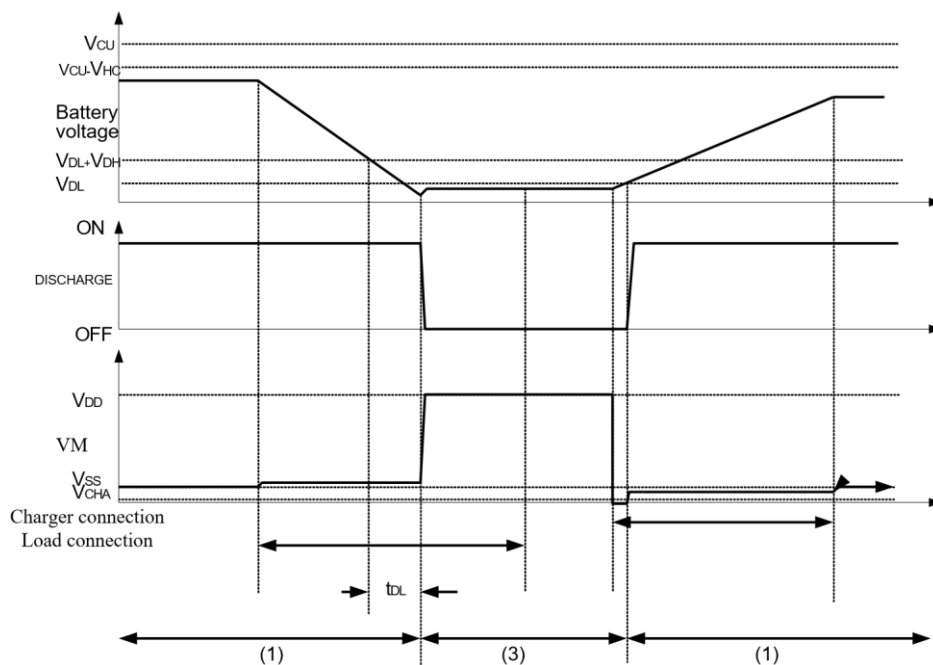


Figure5-3 Charger Detection

### Remark:

- (1) Normal condition (2) Overcharge voltage condition  
(3) Overdischarge voltage condition (4) Overcurrent condition

## Pin Description

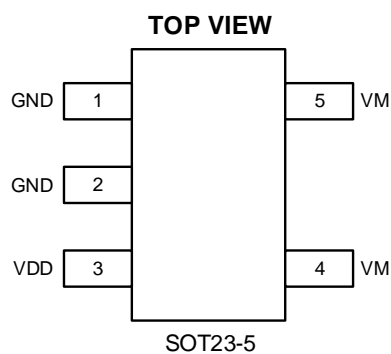


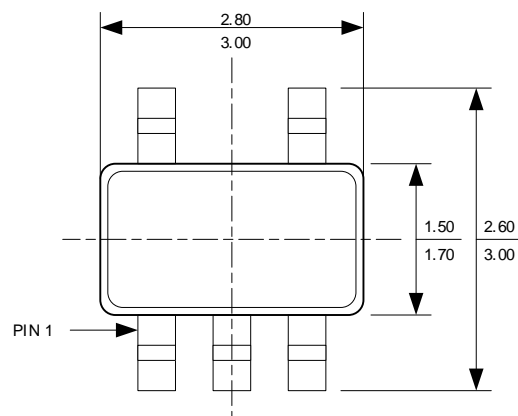
Figure 2. Pin Configuration

## Pin Description

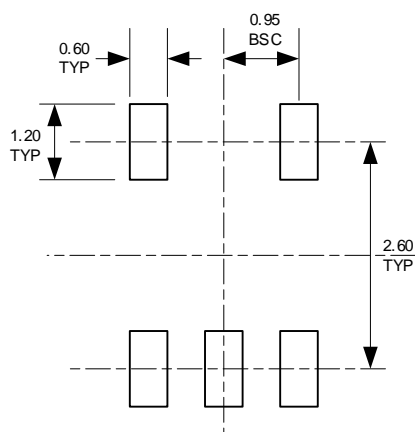
Pin	Name	Function
1	GND	Ground Pin
2	GND	Ground Pin
3	VDD	Power Supply Pin
4	VM	The negative terminal of the battery pack. The internal FET switch connects this terminal to GND
5	VM	The negative terminal of the battery pack. The internal FET switch connects this terminal to GND

## Package Description

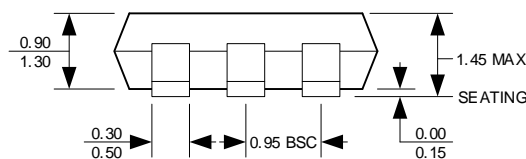
## SOT23-5



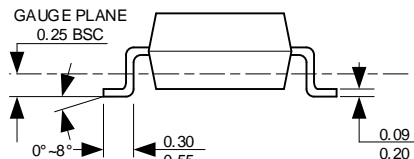
**TOP VIEW**



**RECOMMENDED PAD LAYOUT**




**FRONT VIEW**



**SIDE VIEW**

**NOTE:**

1. CONTROL DIMENSION IS IN INCHES. DIMENSION IN BRACKET IS IN MILLIMETERS.
2. PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
3. PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
4. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.004" INCHES MAX.
5. DRAWING CONFORMS TO JEDEC MS-012, VARIATION BA.
6. DRAWING IS NOT TO SCALE.

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